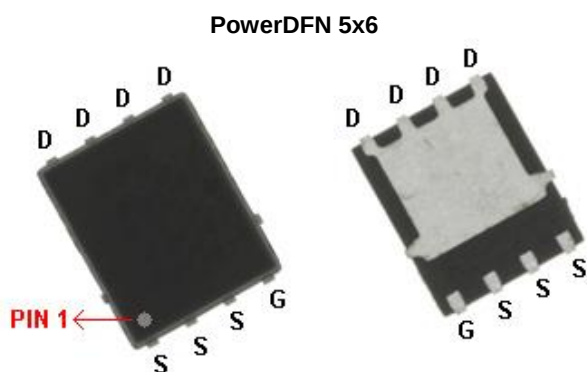


N-Channel 30V(D-S) Enhancement MOSFET

GENERAL DESCRIPTION

The ME7686-G is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as notebook computer power management and other battery powered circuits where high-side switching , and low in-line power loss are needed in a very small outline surface mount package.

PIN CONFIGURATION



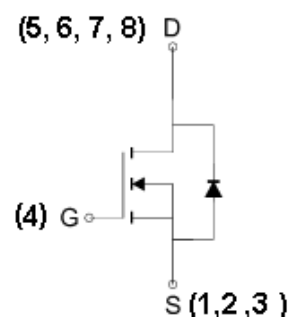
Ordering Information: ME7686/ME7686-G (Green product-Halogen free)

FEATURES

- $R_{DS(ON)} \leq 10.5m\Omega @ V_{GS}=10V$
- $R_{DS(ON)} \leq 18m\Omega @ V_{GS}=4.5V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

APPLICATIONS

- Power Management in Note book
- NB/MB High side switching
- Battery Powered System
- DC/DC Converter
- Load Switch



N-Channel MOSFET

Absolute Maximum Ratings (T_A=25°C Unless Otherwise Noted)

Parameter		Symbol	Maximum Ratings	Unit
Drain-Source Voltage		V _{DS}	30	V
Gate-Source Voltage		V _{GS}	±20	V
Continuous Drain Current	T _A =25°C	I _D	12.9	A
	T _A =70°C		10	
Pulsed Drain Current		I _{DM}	51	A
Maximum Power Dissipation	T _A =25°C	P _D	2.8	W
	T _A =70°C		1.8	
Operating Junction Temperature		T _J	-55 to 150	°C
Thermal Resistance-Junction to Ambient*		R _{θJA}	45	°C/W

*The device mounted on 1in² FR4 board with 2 oz copper

N-Channel 30V(D-S) Enhancement MOSFET

Electrical Characteristics (TA=25°C Unless Otherwise Specified)

Symbol	Parameter	Limit	Min	Typ	Max	Unit
STATIC						
V(BR)DSS	Drain-Source Breakdown Voltage	VGS=0V, ID=250 μ A	30			V
VGS(th)	Gate Threshold Voltage	VDS=VGS, ID=250 μ A	1.2		3.0	V
IGSS	Gate Leakage Current	VDS=0V, VGS=±20V			±100	nA
IDSS	Zero Gate Voltage Drain Current	VDS=30V, VGS=0V			1	μ A
RDS(ON)	Drain-Source On-State Resistance ^a	VGS=10V, ID=15A		8	10.5	m Ω
		VGS=4.5V, ID=12A		13	18	
VSD	Diode Forward Voltage	IS=2.8A, VGS=0V		0.75	1.1	V
DYNAMIC						
Qg	Total Gate Charge	VDS=15V, VGS=4.5V, ID=15A		11		nC
Qgs	Gate-Source Charge			5		
Qgd	Gate-Drain Charge			6		
Ciss	Input Capacitance	VDS=15V, VGS=0V, F=1MHz		914		pF
Coss	Output Capacitance			128		
Crss	Reverse Transfer Capacitance			88		
td(on)	Turn-On Delay Time	VDS=15V, RL=15 Ω VGS=10V, RG=6 Ω ID=1A,		13		ns
tr	Turn-On Rise Time			15		
td(off)	Turn-Off Delay Time			47		
tf	Turn-Off Fall Time			5		

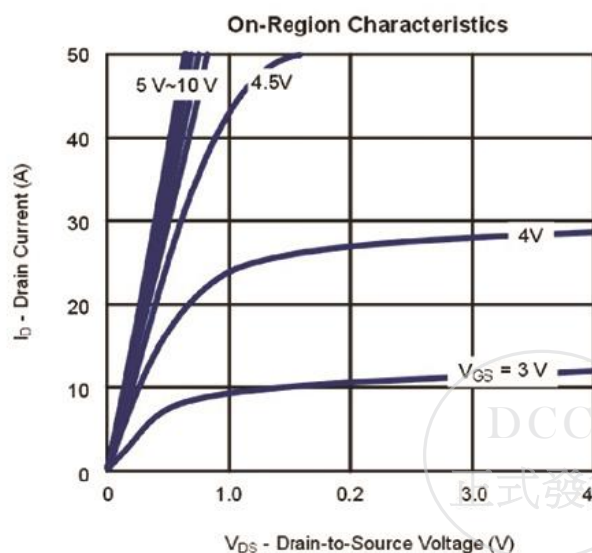
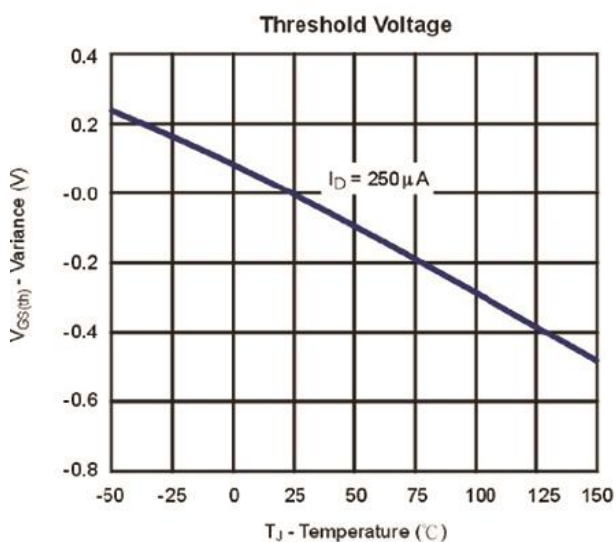
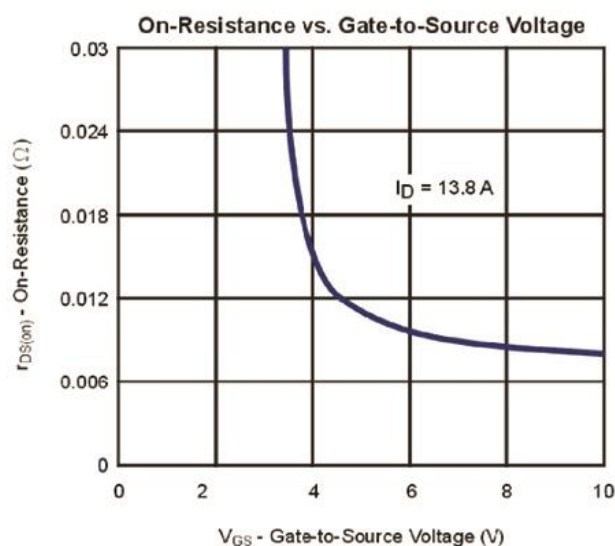
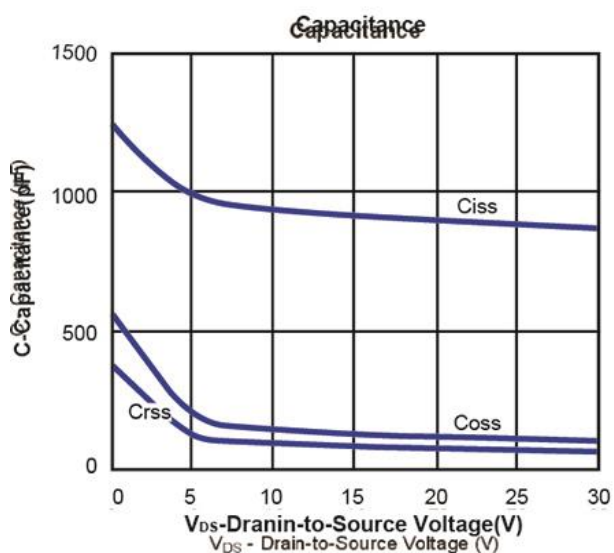
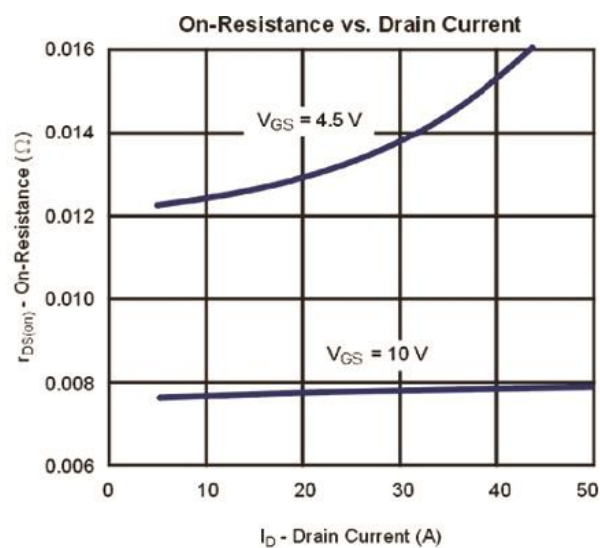
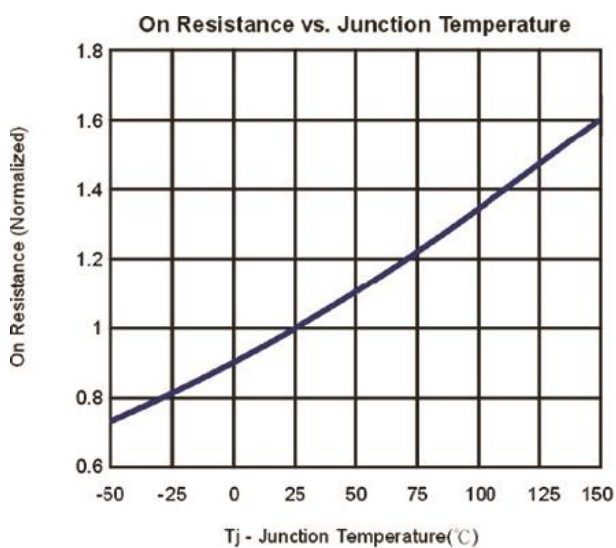
Note: a. Pulse test: pulse width $\leq 300\mu$ s, duty cycle $\leq 2\%$

b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.



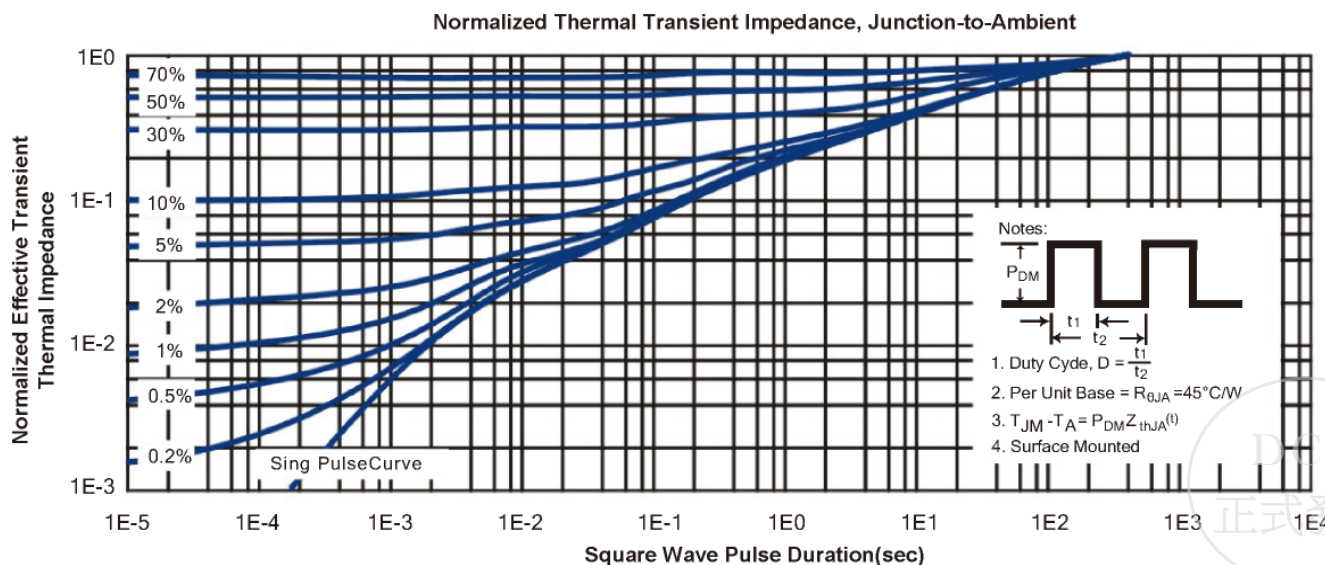
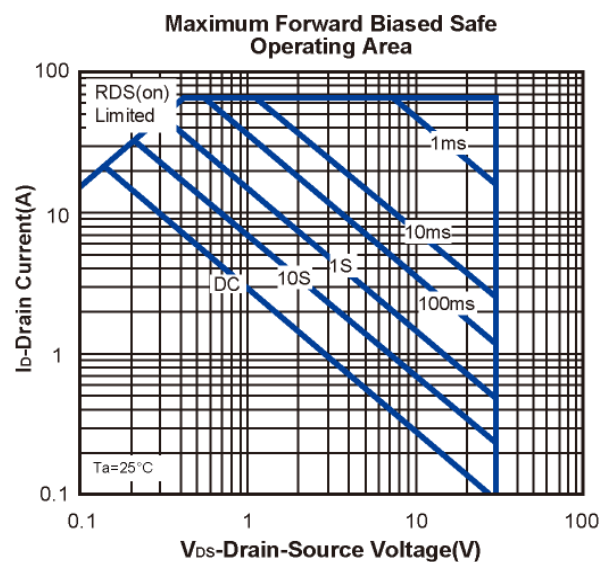
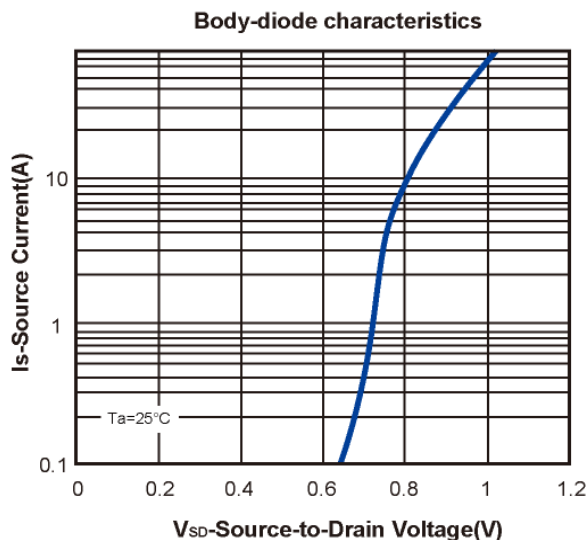
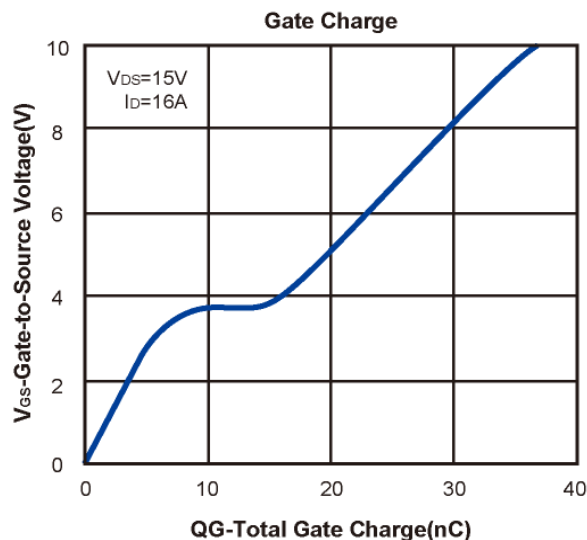
N-Channel 30V(D-S) Enhancement MOSFET

Typical Characteristics (T_J = 25°C Noted)

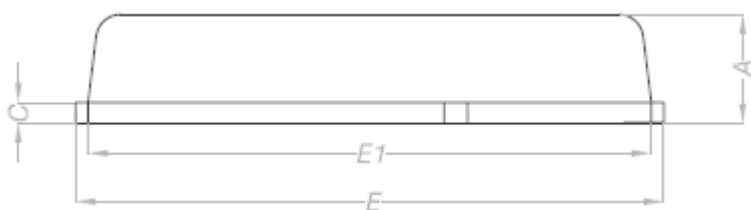
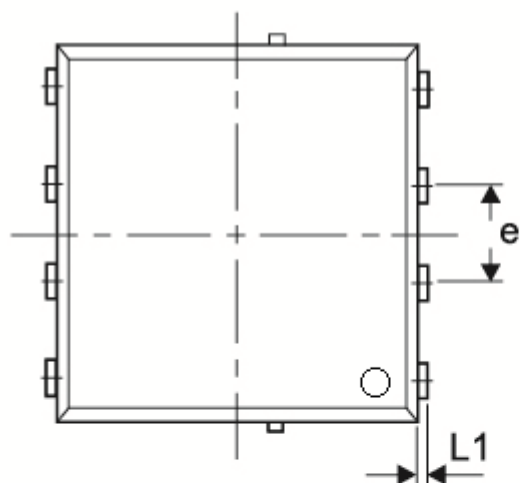
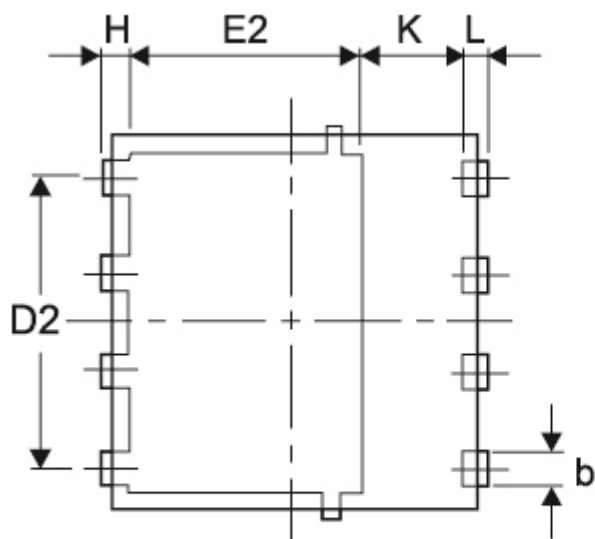


N-Channel 30V(D-S) Enhancement MOSFET

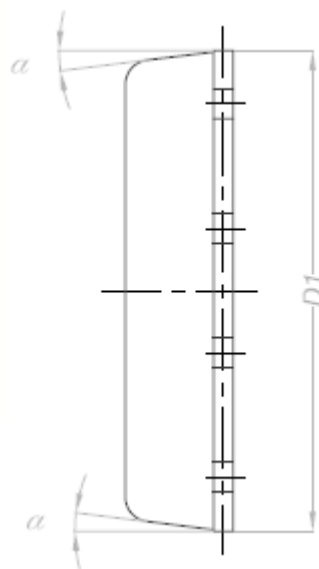
Typical Characteristics (T_J =25°C Noted)



PowerDFN 5x6 Package Outline



DIM.	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.90	1.00	1.10
b	0.33	0.41	0.51
C	0.20	0.25	0.30
D1	4.80	4.90	5.00
D2	3.61	3.81	3.96
E	5.90	6.00	6.10
E1	5.70	5.75	5.80
E2	3.38	3.58	3.78
e	1.27 BSC		
H	0.41	0.51	0.61
K	1.10	-	-
L	0.51	0.61	0.71
L1	0.06	0.13	0.20
α	0°	-	12°



DCC
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